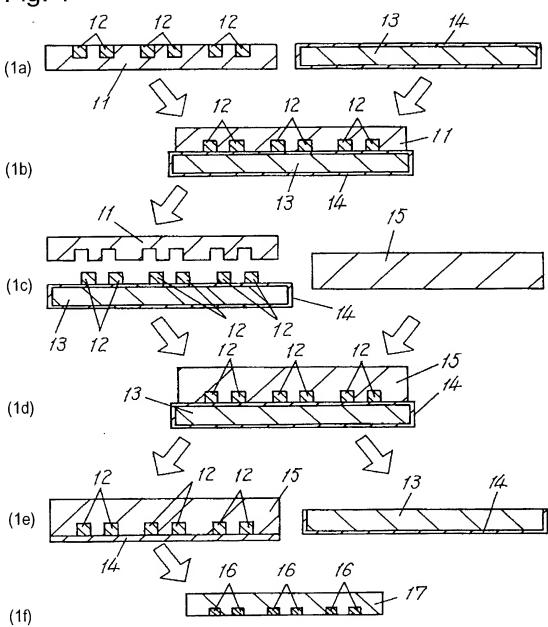
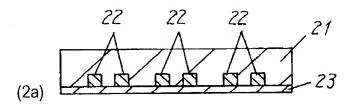
1/11

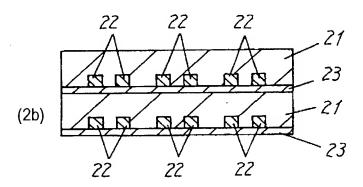
Fig. 1

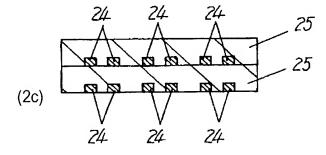


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Fig. 2

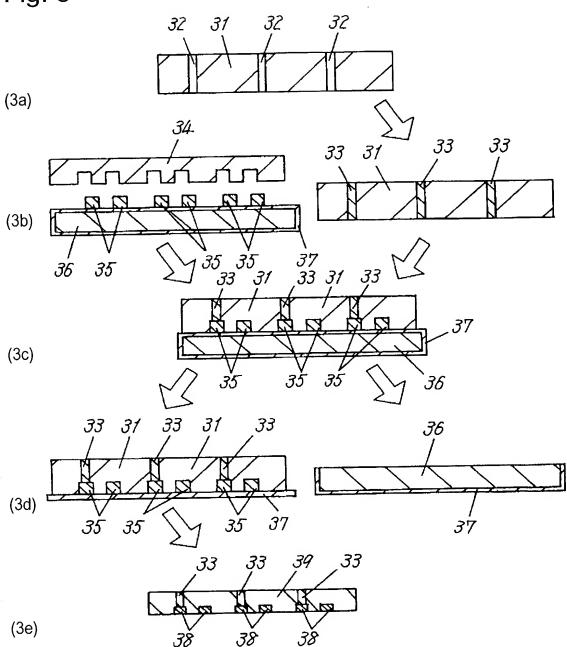


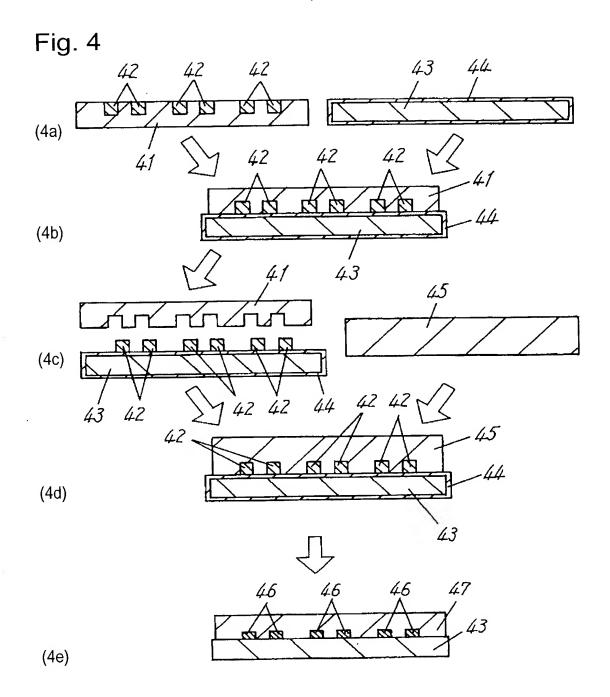




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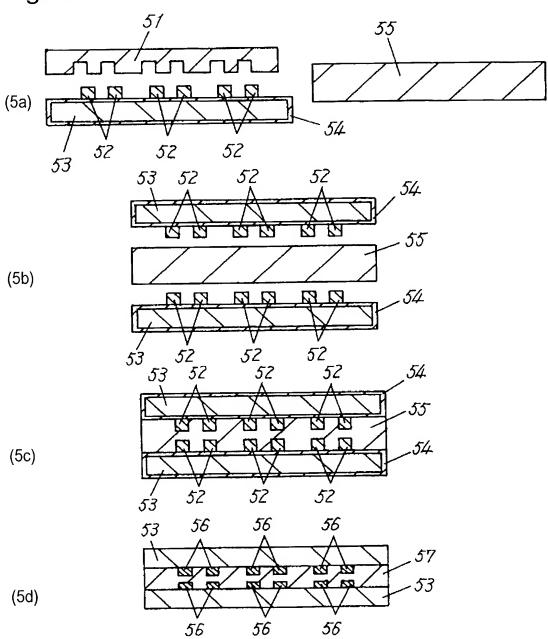
Fig. 3





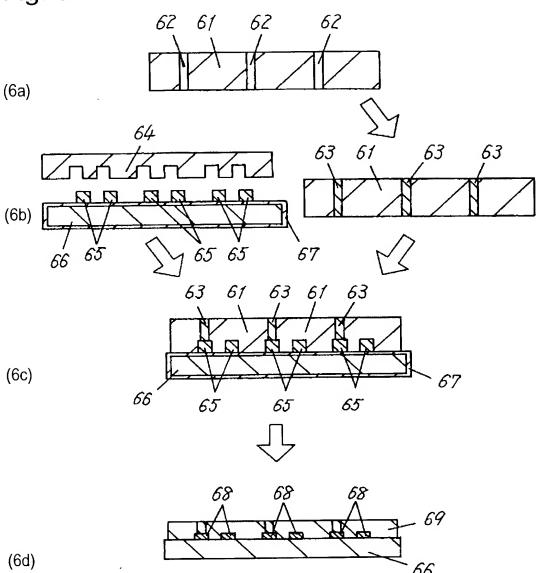
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Fig. 5



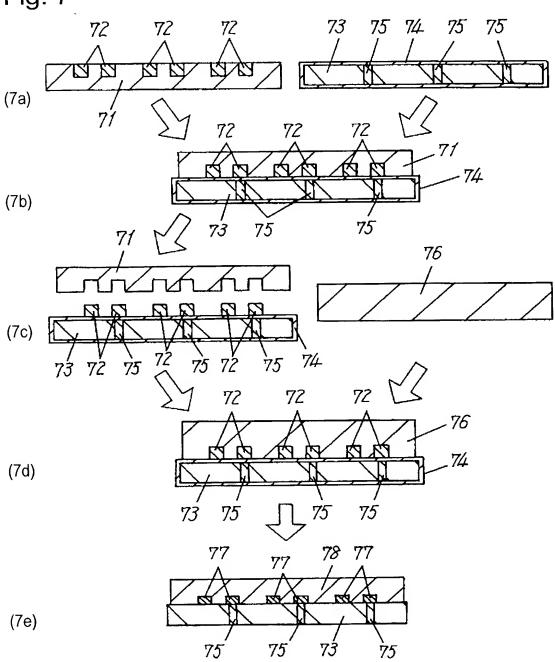
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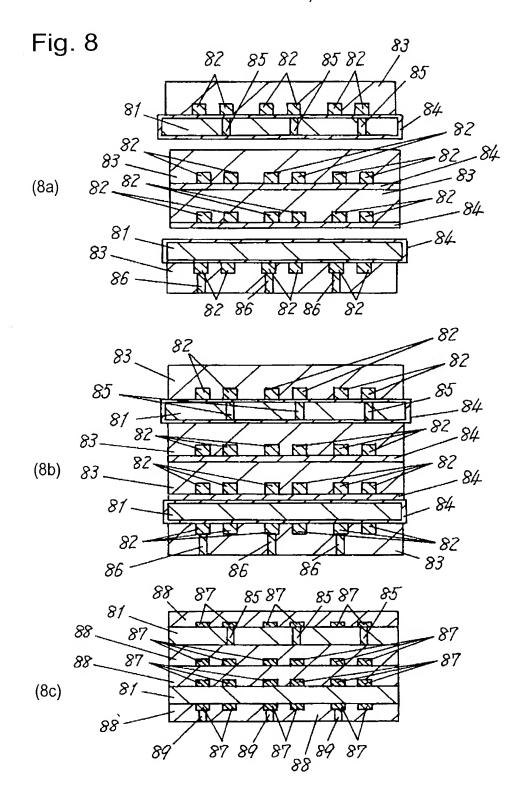


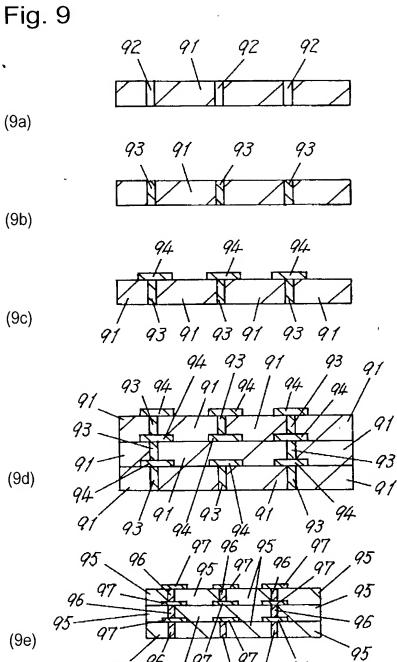
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Fig. 7



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Reference Numerals

- 11 Intaglio
- 12 Conductive Paste
- 13 Heat-Resistant Substrate
- 14 Adhesive Layer
- 15 Un-Sintered Ceramic Green Sheet
- 16 Sintered Conductive Pattern
- 17 Sintered Ceramic Substrate
- 21 Un-Sintered Ceramic Green Sheet
- 22 Conductive Paste
- 23 Adhesive Layer
- 24 Sintered Conductive Pattern
- 25 Sintered Ceramic Substrate
- 31 Un-Sintered Ceramic Green Sheet
- 32 Through-Hole
- 33 Via-Conductor
- 34 Intaglio
- 35 Conductive Layer
- 36 Heat-Resistant Substrate
- 37 Adhesive Layer
- 38 Sintered Conductive Pattern
- 39 Sintered Ceramic Substrate
- 41 Polyimide Intaglio
- 42 Conductive Paste
- 43 Sintered Ceramic Substrate
- 44 Adhesive Layer
- 45 Un-Sintered Ceramic Green Sheet
- 46 Sintered Conductive Pattern
- 47 Sintered Ceramic Substrate
- 51 Intaglio
- 52 Conductive Paste
- 53 Sintered Ceramic Substrate
- 54 Adhesive Layer
- 55 Green Sheet
- 56 Sintered Conductive Pattern
- 57 Un-Sintered Ceramic Green Sheet
- 61 Green Sheet
- 62 Through-Hole
- 63 Via-Conductor
- 64 Intaglio
- 65 Conductive Pattern
- 66 Sintered Ceramic Substrate
- 67 Adhesive Layer
- 68 Sintered Conductive Pattern
- 69 Sintered Ceramic Substrate
- 71 Polyimide Intaglio

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- 72 Conductive Paste
- 73 Sintered Ceramic Substrate
- 74 Adhesive Layer
- 75 Via-Conductor
- 76 Green Sheet
- 77 Sintered Conductive Pattern
- 82 Conductive Paste
- 83 Green Sheet
- 84 Adhesive Layer
- 85 Via-Conductor
- 86 Via-Conductor
- 87 Sintered Conductive Pattern
- 88 Sintered Ceramic Substrate
- 89 Via-Conductor
- 91 Un-Sintered Ceramic Green Sheet
- 92 Through-Hole
- 93 Via-Conductor
- 94 Conductive Pattern
- 95 Sintered Ceramic Substrate
- 96 Sintered Via Conductor
- 97 Sintered Conductive Pattern